## Information we need from your organization

<table>
<thead>
<tr>
<th><strong>Title</strong></th>
<th>Multichip Module Housing</th>
</tr>
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<tbody>
<tr>
<td><strong>Description</strong></td>
<td>General Dynamics Mission Systems is looking for suppliers of a Multichip Module (<strong>MCM</strong>) Housing.</td>
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</table>

### Focus Area(s)

Requirements are:

- Machine Kovar material
- Surface shall have cutter steps no greater than 500 microinches in depth
- Be able to braze in copper molybdenum inserts using gold copper braze material
- Plate housings (including inserts) with electroplated nickel and gold
- Glass seal DC feedthrus
- Braze in RF feedthrus using gold tin braze material
- Gold plating on DC and RF feedthrus shall be ribbon/wire bondable
- Coordinate Measurement Machine (CMM) inspection shall be programmable

### Keyword(s)

- MCM, multichip module housing, braze, plate housings

### Response Instructions & Date

**Responses will be accepted thru 6/26/2020**

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**Send email response including product information in the form of a datasheet to techscout@gd-ms.com**

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### Questions

Email the Innovation Sourcing Network with any questions or required clarification at techscout@gd-ms.com.